



**THE DATASHEET OF
LMV931IDCKRG4**



1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT

Check for Samples: [LMV932 DUAL](#), [LMV934 QUAD](#), [LMV931 SINGLE](#)

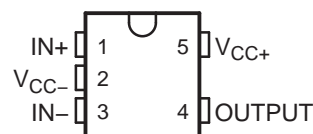
FEATURES

- 1.8-V, 2.7-V, and 5-V Specifications
- Rail-to-Rail Output Swing
 - 600- Ω Load . . . 80 mV From Rail
 - 2-k Ω Load . . . 30 mV From Rail
- V_{ICR} . . . 200 mV Beyond Rails
- Gain Bandwidth . . . 1.4 MHz
- Supply Current . . . 100 μ A/Amplifier
- Max V_{IO} . . . 4 mV
- Space-Saving Packages
 - LMV931: SOT-23 and SC-70
 - LMV932: MSOP and SOIC
 - LMV934: SOIC and TSSOP

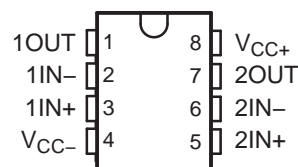
APPLICATIONS

- Industrial (Utility/Energy Metering)
- Automotive
- Communications (Optical Telecom, Data/Voice Cable Modems)
- Consumer Electronics (PDAs, PCs, CDR/W, Portable Audio)
- Supply-Current Monitoring
- Battery Monitoring

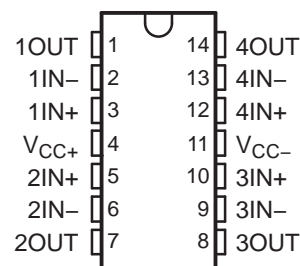
LMV931 . . . DBV (SOT-23-5) OR DCK (SC-70) PACKAGE
(TOP VIEW)



LMV932 . . . D (SOIC) OR
DGK (VSSOP/MSOP) PACKAGE
(TOP VIEW)



LMV934 . . . D (SOIC) OR PW (TSSOP) PACKAGE
(TOP VIEW)



DESCRIPTION/ORDERING INFORMATION



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

ORDERING INFORMATION

| T _A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING ⁽²⁾ | |
|----------------|------------------------|------------------|-----------------------|---------------------------------|---------|
| -40°C to 125°C | Single | SOT-23 – DBV | Reel of 3000 | LMV931IDBVR | RBB_ |
| | | | Reel of 250 | LMV931IDBVT | PREVIEW |
| | | SC-70 – DCK | Reel of 3000 | LMV931IDCKR | RB_ |
| | | | Reel of 250 | LMV931IDCKT | PREVIEW |
| | Dual | MSOP/VSSOP – DGK | Reel of 2500 | LMV932IDGKR | RD_ |
| | | | Reel of 250 | LMV932IDGKT | PREVIEW |
| | | SOIC – D | Tube of 75 | LMV932ID | MV932I |
| | | | Reel of 2500 | LMV932IDR | |
| | Quad | SOIC – D | Tube of 50 | LMV934ID | LMV934I |
| | | | Reel of 2500 | LMV934IDR | |
| | | TSSOP – PW | Tube of 90 | LMV934IPW | MV934I |
| | | | Reel of 2000 | LMV934IPWR | |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) DBV/DCK/DGK: The actual top-side marking has one additional character that designates the assembly/test site.

DESCRIPTION/ORDERING INFORMATION (CONTINUED)

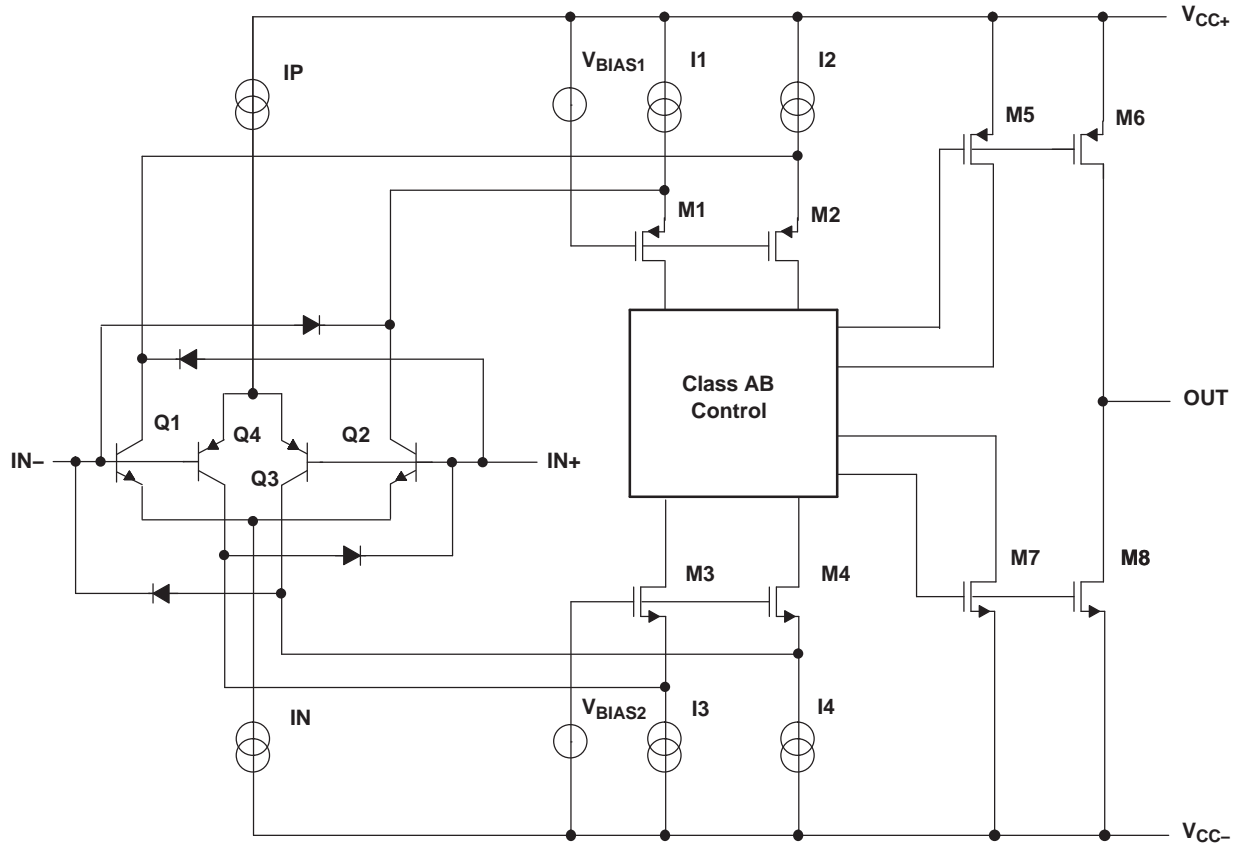
The LMV93x devices are low-voltage low-power operational amplifiers that are well suited for today's low-voltage and/or portable applications. Specified for operation of 1.8 V to 5 V, they can be used in portable applications that are powered from a single-cell Li-ion or two-cell batteries. They have rail-to-rail input and output capability for maximum signal swings in low-voltage applications. The LMV93x input common-mode voltage extends 200 mV beyond the rails for increased flexibility. The output can swing rail-to-rail unloaded and typically can reach 80 mV from the rails, while driving a 600-Ω load (at 1.8-V operation).

During 1.8-V operation, the devices typically consume a quiescent current of 103 μA per channel, and yet they are able to achieve excellent electrical specifications, such as 101-dB open-loop DC gain and 1.4-MHz gain bandwidth. Furthermore, the amplifiers offer good output drive characteristics, with the ability to drive a 600-Ω load and 1000-pF capacitance with minimal ringing.

The LMV93x devices are offered in the latest packaging technology to meet the most demanding space-constraint applications. The LMV931 is offered in standard SOT-23 and SC-70 packages. The LMV932 is available in the traditional MSOP and SOIC packages. The LMV934 is available in the traditional SOIC and TSSOP packages.

The LMV93x devices are characterized for operation from -40°C to 125°C, making the part universally suited for commercial, industrial, and automotive applications.

Figure 1. SIMPLIFIED SCHEMATIC



Absolute Maximum Ratings⁽¹⁾

over free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT |
|--|--|--------------------|-----------------|------|
| $V_{CC+} - V_{CC-}$ | Supply voltage ⁽²⁾ | | 5.5 | V |
| V_{ID} | Differential input voltage ⁽³⁾ | Supply voltage | | |
| V_I | Input voltage range, either input | $V_{CC-} - 0.2$ | $V_{CC+} + 0.2$ | V |
| Duration of output short circuit (one amplifier) to $V_{CC\pm}$ ^{(4) (5)} | | Unlimited | | |
| θ_{JA} | Package thermal impedance ^{(5) (6)} | D package (8 pin) | | °C/W |
| | | D package (14 pin) | | |
| | | DBV package | | |
| | | DCK package | | |
| | | DGK package | | |
| | | PW package | | |
| T_J | Operating virtual junction temperature | | 150 | °C |
| T_{stg} | Storage temperature range | -65 | 150 | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
- (3) Differential voltages are at IN+ with respect to IN-.
- (4) Applies to both single-supply and split-supply operation. Continuous short-circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability.
- (5) Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions

| | | MIN | MAX | UNIT |
|----------|--|-----|-----|------|
| V_{CC} | Supply voltage ($V_{CC+} - V_{CC-}$) | 1.8 | 5 | V |
| T_A | Operating free-air temperature | -40 | 125 | °C |

ESD Protection

| | TYP | UNIT |
|------------------|------|------|
| Human-Body Model | 2000 | V |
| Machine Model | 200 | V |

Electrical Characteristics
 $V_{CC+} = 1.8\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, and $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | T_A | MIN | TYP | MAX | UNIT | |
|--|---|--|--|--|---------------------------------------|-----------------|-----------------|------------------------------|----|
| V_{IO} | Input offset voltage | LMV931 (single) | | 25°C | | 1 | 4 | mV | |
| | | | | Full range | | | 6 | | |
| | | LMV932 (dual), LMV934 (quad) | | 25°C | | 1 | 5.5 | | |
| | | | | Full range | | | 7.5 | | |
| $\alpha_{V_{IO}}$ | Average temperature coefficient of input offset voltage | | | 25°C | | 5.5 | | $\mu\text{V}/^\circ\text{C}$ | |
| I_{IB} | Input bias current | $V_{IC} = V_{CC+} - 0.8\text{ V}$ | | 25°C | | 15 | 35 | nA | |
| | | | | 25°C | | | 65 | | |
| | | | | Full range | | | 75 | | |
| I_{IO} | Input offset current | | | 25°C | | 13 | 25 | nA | |
| | | | | Full range | | | 40 | | |
| I_{CC} | Supply current (per channel) | | | 25°C | | 103 | 185 | μA | |
| | | | | Full range | | | 205 | | |
| CMRR | Common-mode rejection ratio | $0 \leq V_{IC} \leq 0.6\text{ V}$, $1.4\text{ V} \leq V_{IC} \leq 1.8\text{ V}$ | | 25°C | 60 | 78 | dB | | |
| | | | | -40°C to 85°C | 55 | | | | |
| | | $0.2 \leq V_{IC} \leq 0.6\text{ V}$, $1.4\text{ V} \leq V_{IC} \leq 1.6\text{ V}$ | -40°C to 125°C | 55 | | | | | |
| k_{SVR} | Supply-voltage rejection ratio | $1.8\text{ V} \leq V_{CC+} \leq 5\text{ V}$, $V_{IC} = 0.5\text{ V}$ | | 25°C | 75 | 100 | dB | | |
| | | | | Full range | 70 | | | | |
| V_{ICR} | Common-mode input voltage range | CMRR $\geq 50\text{ dB}$ | | 25°C | $V_{CC-} - 0.2$ | -0.2 to 2.1 | $V_{CC+} + 0.2$ | V | |
| | | | | -40°C to 85°C | V_{CC-} | | V_{CC+} | | |
| | | | | -40°C to 125°C | $V_{CC-} + 0.2$ | | $V_{CC+} - 0.2$ | | |
| A_V | Large-signal voltage gain | LMV931 | $V_O = 0.2\text{ V}$ to 1.6 V , $V_{IC} = 0.5\text{ V}$ | $R_L = 600\ \Omega$ to 0.9 V | 25°C | 77 | 101 | dB | |
| | | | | | Full range | 73 | | | |
| | | | | $R_L = 2\text{ k}\Omega$ to 0.9 V | 25°C | 80 | 105 | | |
| | | | | | Full range | 75 | | | |
| | | | | LMV932, LMV934 | $R_L = 600\ \Omega$ to 0.9 V | 25°C | 75 | | 90 |
| | | | | | | Full range | 72 | | |
| $R_L = 2\text{ k}\Omega$ to 0.9 V | 25°C | 78 | 100 | | | | | | |
| | Full range | 75 | | | | | | | |
| V_O | Output swing | $R_L = 600\ \Omega$ to 0.9 V , $V_{ID} = \pm 100\text{ mV}$ | High level | 25°C | 1.65 | 1.72 | V | | |
| | | | | Full range | 1.63 | | | | |
| | | | Low level | 25°C | | 0.077 | | 0.105 | |
| | | | | Full range | | | | 0.120 | |
| | | | $R_L = 2\text{ k}\Omega$ to 0.9 V , $V_{ID} = \pm 100\text{ mV}$ | High level | 25°C | 1.75 | | 1.77 | |
| | | | | | Full range | 1.74 | | | |
| Low level | 25°C | | 0.024 | 0.035 | | | | | |
| | Full range | | | 0.040 | | | | | |
| I_{OS} | Output short-circuit current | $V_O = 0\text{ V}$, $V_{ID} = 100\text{ mV}$ | Sourcing | 25°C | 4 | 8 | mA | | |
| | | | | Full range | 3.3 | | | | |
| | | $V_O = 1.8\text{ V}$, $V_{ID} = -100\text{ mV}$ | Sinking | 25°C | 7 | 9 | | | |
| | | | | Full range | 5 | | | | |
| GBW | Gain bandwidth product | | | 25°C | | 1.4 | | MHz | |

Electrical Characteristics (continued)

$V_{CC+} = 1.8\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, and $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | T _A | MIN | TYP | MAX | UNIT |
|-----------|---|---|------|-------|-----|------------------------|
| SR | Slew rate ⁽¹⁾ | 25°C | | 0.35 | | V/ μ S |
| Φ_m | Phase margin | 25°C | | 67 | | ° |
| | Gain margin | 25°C | | 7 | | dB |
| V_n | Equivalent input noise voltage | $f = 1\text{ kHz}$, $V_{IC} = 0.5\text{ V}$ | | 60 | | nV/ $\sqrt{\text{Hz}}$ |
| I_n | Equivalent input noise current | $f = 1\text{ kHz}$ | | 0.06 | | pA/ $\sqrt{\text{Hz}}$ |
| THD | Total harmonic distortion | $f = 1\text{ kHz}$, $A_V = 1$, $R_L = 600\ \Omega$, $V_{ID} = 1\text{ V}_{p-p}$ | | 0.023 | | % |
| | Amplifier-to-amplifier isolation ⁽²⁾ | | 25°C | 123 | | dB |

(1) Number specified is the slower of the positive and negative slew rates.

(2) Input referred, $V_{CC+} = 5\text{ V}$ and $R_L = 100\text{ k}\Omega$ connected to 2.5 V. Each amplifier is excited, in turn, with a 1-kHz signal to produce $V_O = 3\text{ V}_{p-p}$.

Electrical Characteristics
 $V_{CC+} = 2.7\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, and $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | T_A | MIN | TYP | MAX | UNIT | | | |
|-------------------|---|--|--|-------------------------------|---|------------|-----------------|------------------------------|----|----|----|
| V_{IO} | Input offset voltage | LMV931 (single) | | 25°C | | 1 | 4 | mV | | | |
| | | | | Full range | | | 6 | | | | |
| | | LMV932 (dual), LMV934 (quad) | | 25°C | | 1 | 5.5 | | | | |
| | | | | Full range | | | 7.5 | | | | |
| $\alpha_{V_{IO}}$ | Average temperature coefficient of input offset voltage | | | 25°C | | 5.5 | | $\mu\text{V}/^\circ\text{C}$ | | | |
| I_{IB} | Input bias current | $V_{IC} = V_{CC+} - 0.8\text{ V}$ | | 25°C | | 15 | 35 | nA | | | |
| | | | | 25°C | | | 65 | | | | |
| | | | | Full range | | | 75 | | | | |
| I_{IO} | Input offset current | | | 25°C | | 8 | 25 | nA | | | |
| | | | | Full range | | | 40 | | | | |
| I_{CC} | Supply current (per channel) | | | 25°C | | 105 | 190 | μA | | | |
| | | | | Full range | | | 210 | | | | |
| CMRR | Common-mode rejection ratio | $0 \leq V_{IC} \leq 1.5\text{ V}$, $2.3\text{ V} \leq V_{IC} \leq 2.7\text{ V}$ | | 25°C | 60 | 81 | dB | | | | |
| | | | | -40°C to 85°C | 55 | | | | | | |
| | | | | -40°C to 125°C | 55 | | | | | | |
| k_{SVR} | Supply-voltage rejection ratio | $1.8\text{ V} \leq V_{CC+} \leq 5\text{ V}$, $V_{IC} = 0.5\text{ V}$ | | 25°C | 75 | 100 | dB | | | | |
| | | | | Full range | 70 | | | | | | |
| | | | | | | | | | | | |
| V_{ICR} | Common-mode input voltage range | CMRR $\geq 50\text{ dB}$ | | 25°C | $V_{CC-} - 0.2$ | -0.2 to 3 | $V_{CC+} + 0.2$ | V | | | |
| | | | | -40°C to 85°C | V_{CC-} | | V_{CC+} | | | | |
| | | | | -40°C to 125°C | $V_{CC-} + 0.2$ | | $V_{CC+} - 0.2$ | | | | |
| A_V | Large-signal voltage gain | LMV931 | $V_O = 0.2\text{ V to } 2.5\text{ V}$ | $R_L = 600\ \Omega$ to 1.35 V | 25°C | 87 | 104 | dB | | | |
| | | | | Full range | 86 | | | | | | |
| | | $R_L = 2\text{ k}\Omega$ to 1.35 V | | 25°C | 92 | 110 | | | | | |
| | | Full range | | 91 | | | | | | | |
| | | LMV932, LMV934 | | $R_L = 600\ \Omega$ to 1.35 V | 25°C | 78 | 90 | | | | |
| | | | | Full range | 75 | | | | | | |
| V_O | Output swing | $R_L = 600\ \Omega$ to 1.35 V, $V_{ID} = \pm 100\text{ mV}$ | High level | 25°C | 2.55 | 2.62 | V | | | | |
| | | | | Full range | 2.53 | | | | | | |
| | | | Low level | 25°C | | 0.083 | | 0.11 | | | |
| | | | | Full range | | | | 0.13 | | | |
| | | | $R_L = 2\text{ k}\Omega$ to 1.35 V, $V_{ID} = \pm 100\text{ mV}$ | High level | 25°C | 2.65 | | 2.675 | | | |
| | | | | | Full range | 2.64 | | | | | |
| | | Low level | | 25°C | | 0.025 | | 0.04 | | | |
| | | | | Full range | | | | 0.045 | | | |
| | | I_{OS} | | Output short-circuit current | $V_O = 0\text{ V}$, $V_{ID} = 100\text{ mV}$ | Sourcing | | 25°C | 20 | 30 | mA |
| | | | | | | | | Full range | 15 | | |
| | | | $V_O = 2.7\text{ V}$, $V_{ID} = -100\text{ mV}$ | | Sinking | 25°C | | 18 | 25 | | |
| | | | | | | Full range | | 12 | | | |
| GBW | Gain bandwidth product | | | 25°C | | 1.4 | | MHz | | | |

Electrical Characteristics (continued)

$V_{CC+} = 2.7\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, and $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | T_A | MIN | TYP | MAX | UNIT |
|-----------|---|---|-----|-------|-----|------------------------|
| SR | Slew rate ⁽¹⁾ | 25°C | | 0.4 | | V/ μ S |
| Φ_m | Phase margin | 25°C | | 70 | | ° |
| | Gain margin | 25°C | | 7.5 | | dB |
| V_n | Equivalent input noise voltage | $f = 1\text{ kHz}$, $V_{IC} = 0.5\text{ V}$ | | 57 | | nV/ $\sqrt{\text{Hz}}$ |
| I_n | Equivalent input noise current | $f = 1\text{ kHz}$ | | 0.082 | | pA/ $\sqrt{\text{Hz}}$ |
| THD | Total harmonic distortion | $f = 1\text{ kHz}$, $A_V = 1$, $R_L = 600\ \Omega$, $V_{ID} = 1\text{ V}_{p-p}$ | | 0.022 | | % |
| | Amplifier-to-amplifier isolation ⁽²⁾ | 25°C | | 123 | | dB |

(1) Number specified is the slower of the positive and negative slew rates.

(2) Input referred, $V_{CC+} = 5\text{ V}$ and $R_L = 100\text{ k}\Omega$ connected to 2.5 V. Each amplifier is excited, in turn, with a 1-kHz signal to produce $V_O = 3\text{ V}_{p-p}$.

Electrical Characteristics

 $V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, and $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | T_A | MIN | TYP | MAX | UNIT | |
|-------------------|---|--|--------------------------------------|---|------------------------------|-------------|-----------------|------------------------------|-------|
| V_{IO} | Input offset voltage | LMV931 (single) | | 25°C | | 1 | 4 | mV | |
| | | | | Full range | | | 6 | | |
| | | LMV932 (dual), LMV934 (quad) | | 25°C | | 1 | 5.5 | | |
| | | | | Full range | | | 7.5 | | |
| $\alpha_{V_{IO}}$ | Average temperature coefficient of input offset voltage | | | 25°C | | 5.5 | | $\mu\text{V}/^\circ\text{C}$ | |
| I_{IB} | Input bias current | | | 25°C | | 15 | 35 | nA | |
| | | | | 25°C | | | 65 | | |
| | | | | Full range | | | 75 | | |
| I_{IO} | Input offset current | | | 25°C | | 9 | 25 | nA | |
| | | | | Full range | | | 40 | | |
| I_{CC} | Supply current (per channel) | | | 25°C | | 116 | 210 | μA | |
| | | | | Full range | | | 230 | | |
| CMRR | Common-mode rejection ratio | | | 25°C | 60 | 86 | | dB | |
| | | | | –40°C to 85°C | 55 | | | | |
| | | | | –40°C to 125°C | 55 | | | | |
| k_{SVR} | Supply-voltage rejection ratio | | | 25°C | 75 | 100 | | dB | |
| | | | | Full range | 70 | | | | |
| V_{ICR} | Common-mode input voltage range | CMRR $\geq 50\text{ dB}$ | | 25°C | $V_{CC-} - 0.2$ | –0.2 to 5.3 | $V_{CC+} + 0.2$ | V | |
| | | | | –40°C to 85°C | V_{CC-} | | V_{CC+} | | |
| | | | | –40°C to 125°C | $V_{CC-} + 0.3$ | | $V_{CC+} - 0.3$ | | |
| A_V | Large-signal voltage gain | LMV931 | $V_O = 0.2\text{ V to }4.8\text{ V}$ | $R_L = 600\ \Omega$ to 2.5 V | 25°C | 88 | 102 | dB | |
| | | | | | Full range | 87 | | | |
| | | | | $R_L = 2\text{ k}\Omega$ to 2.5 V | 25°C | 94 | 113 | | |
| | | | | | Full range | 93 | | | |
| | | | | LMV932, LMV934 | $R_L = 600\ \Omega$ to 2.5 V | 25°C | 81 | | 90 |
| | | | | | | Full range | 78 | | |
| | $R_L = 2\text{ k}\Omega$ to 2.5 V | 25°C | 85 | 100 | | | | | |
| | | Full range | 82 | | | | | | |
| V_O | Output swing | | | $R_L = 600\ \Omega$ to 2.5 V, $V_{ID} = \pm 100\text{ mV}$ | 25°C | 4.855 | 4.89 | V | |
| | | | | | Full range | 4.835 | | | |
| | | | | Low level | 25°C | | 0.12 | | 0.16 |
| | | | | | Full range | | | | 0.18 |
| | | | | $R_L = 2\text{ k}\Omega$ to 2.5 V, $V_{ID} = \pm 100\text{ mV}$ | High level | 25°C | 4.945 | | 4.967 |
| | | | | | Full range | 4.935 | | | |
| Low level | 25°C | | 0.037 | 0.065 | | | | | |
| | Full range | | | 0.075 | | | | | |
| I_{OS} | Output short-circuit current | $V_O = 0\text{ V}$, $V_{ID} = 100\text{ mV}$ | Sourcing | 25°C | 80 | 100 | mA | | |
| | | | | Full range | 68 | | | | |
| | | $V_O = 5\text{ V}$, $V_{ID} = -100\text{ mV}$ | Sinking | 25°C | 58 | 65 | | | |
| | | | | Full range | 45 | | | | |
| GBW | Gain bandwidth product | | | 25°C | | 1.5 | | MHz | |

Electrical Characteristics (continued)

$V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $V_{IC} = V_{CC+}/2$, $V_O = V_{CC+}/2$, and $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | T_A | MIN | TYP | MAX | UNIT |
|----------|---|---|-------|-----|-------|-----|------------------------|
| SR | Slew rate ⁽¹⁾ | | 25°C | | 0.42 | | V/ μ S |
| Φ_m | Phase margin | | 25°C | | 71 | | ° |
| | Gain margin | | 25°C | | 8 | | dB |
| V_n | Equivalent input noise voltage | $f = 1\text{ kHz}$, $V_{IC} = 0.5\text{ V}$ | 25°C | | 50 | | nV/ $\sqrt{\text{Hz}}$ |
| I_n | Equivalent input noise current | $f = 1\text{ kHz}$ | 25°C | | 0.07 | | pA/ $\sqrt{\text{Hz}}$ |
| THD | Total harmonic distortion | $f = 1\text{ kHz}$, $A_V = 1$, $R_L = 600\ \Omega$, $V_{ID} = 1\text{ V}_{p-p}$ | 25°C | | 0.022 | | % |
| | Amplifier-to-amplifier isolation ⁽²⁾ | | 25°C | | 123 | | dB |

- (1) Number specified is the slower of the positive and negative slew rates.
 (2) Input referred, $V_{CC+} = 5\text{ V}$ and $R_L = 100\text{ k}\Omega$ connected to 2.5 V. Each amplifier is excited, in turn, with a 1-kHz signal to produce $V_O = 3\text{ V}_{p-p}$.

TYPICAL CHARACTERISTICS

$V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

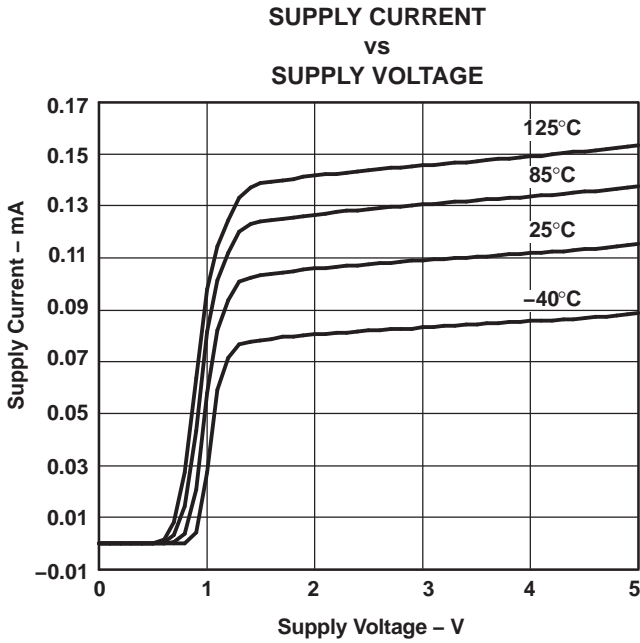


Figure 2.

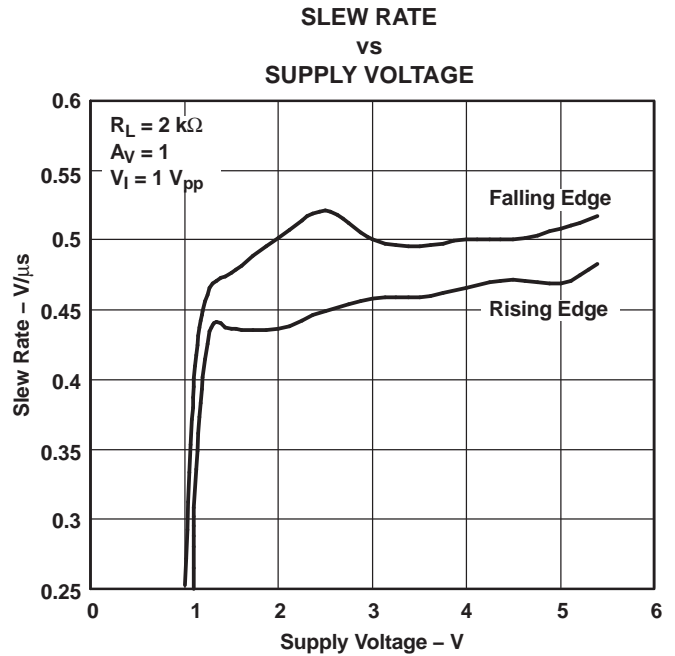


Figure 3.

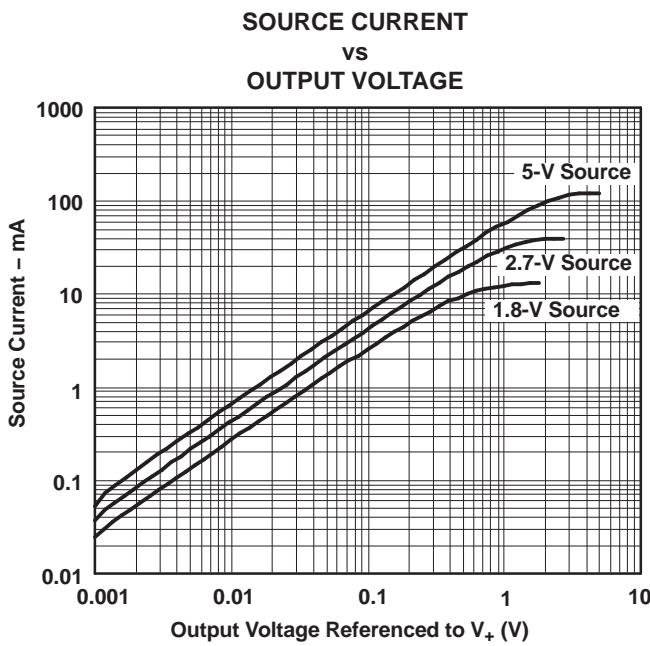


Figure 4.

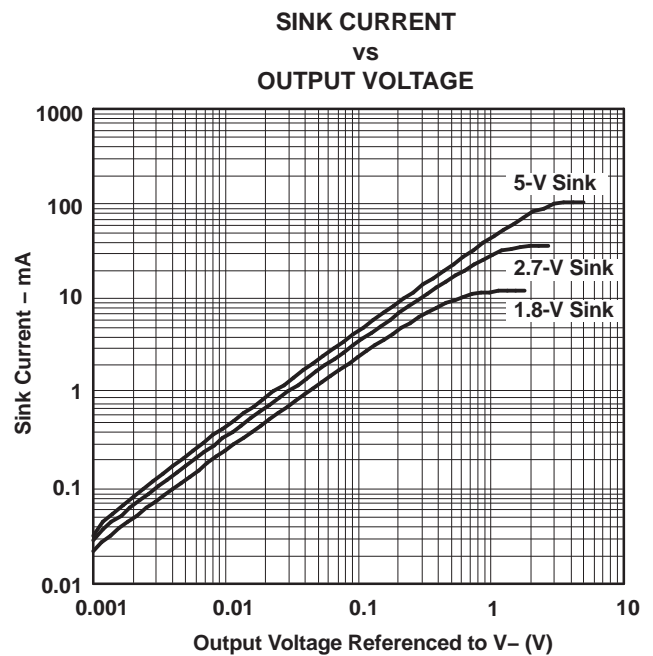


Figure 5.

TYPICAL CHARACTERISTICS (continued)

$V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

**OUTPUT VOLTAGE SWING
 VS
 SUPPLY VOLTAGE**

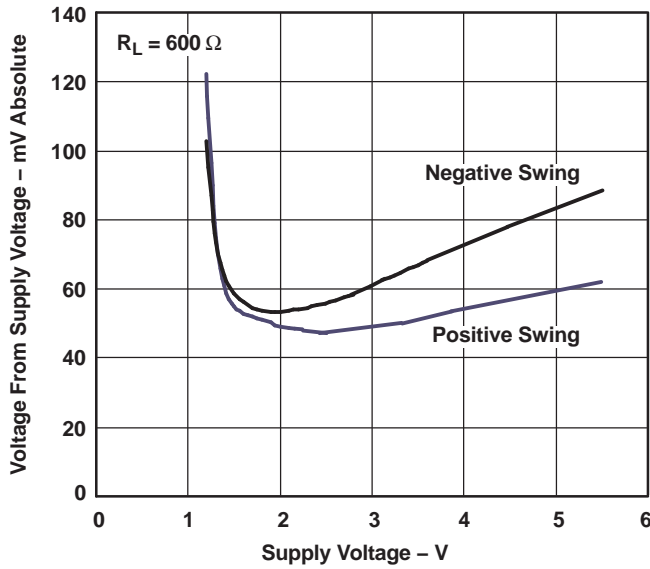


Figure 6.

**OUTPUT VOLTAGE SWING
 VS
 SUPPLY VOLTAGE**

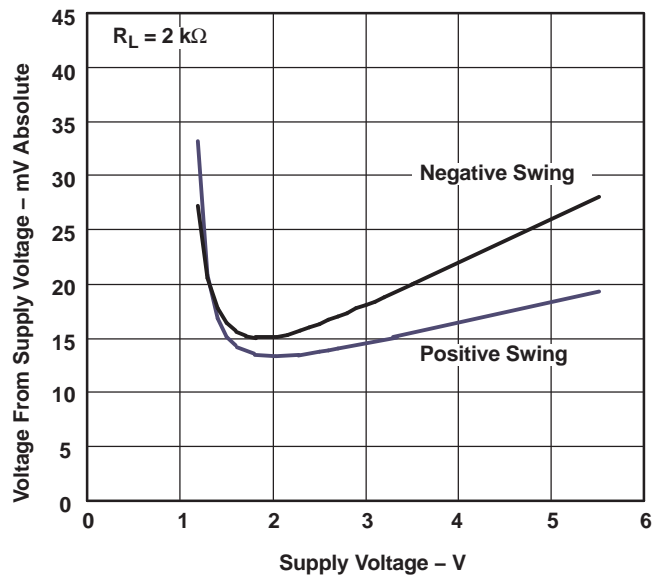


Figure 7.

**SHORT-CIRCUIT CURRENT (SINK)
 VS
 TEMPERATURE**

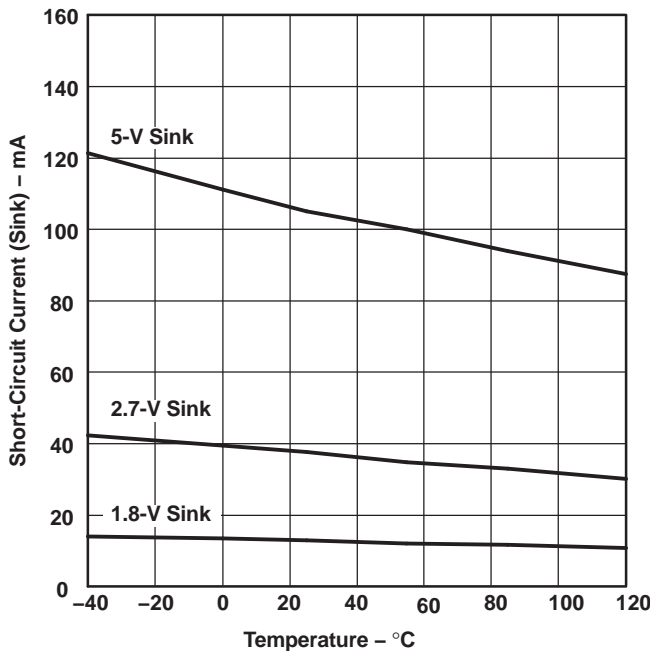


Figure 8.

**SHORT-CIRCUIT CURRENT (SOURCE)
 VS
 TEMPERATURE**

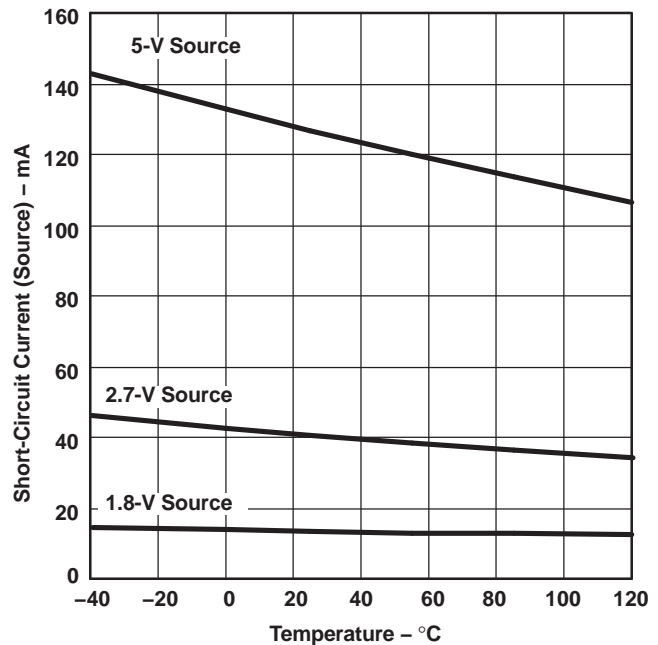


Figure 9.

TYPICAL CHARACTERISTICS (continued)

V_{CC+} = 5 V, Single Supply, T_A = 25°C (unless otherwise specified)

1.8-V FREQUENCY RESPONSE

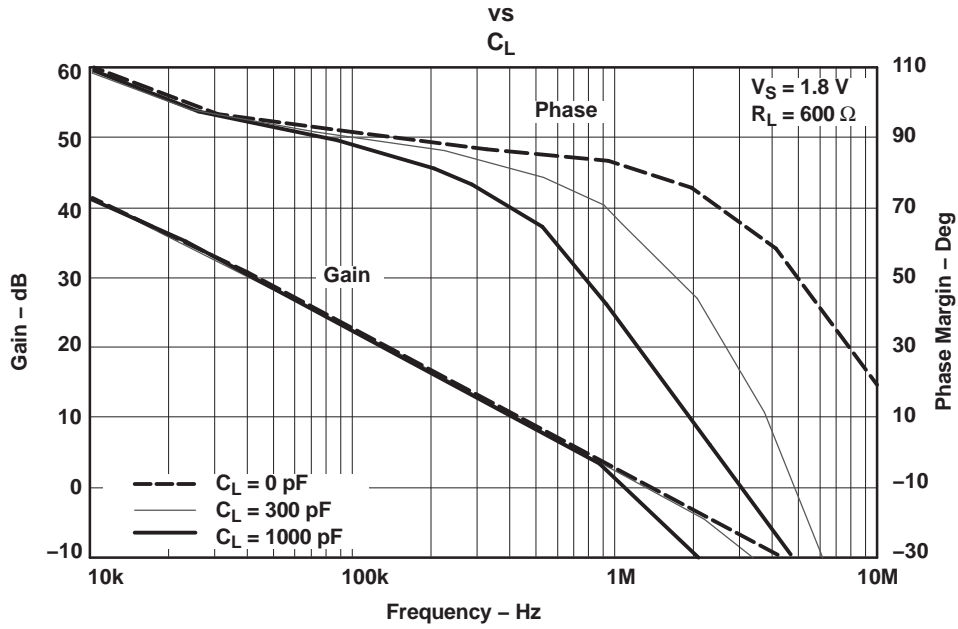


Figure 10.

5-V FREQUENCY RESPONSE

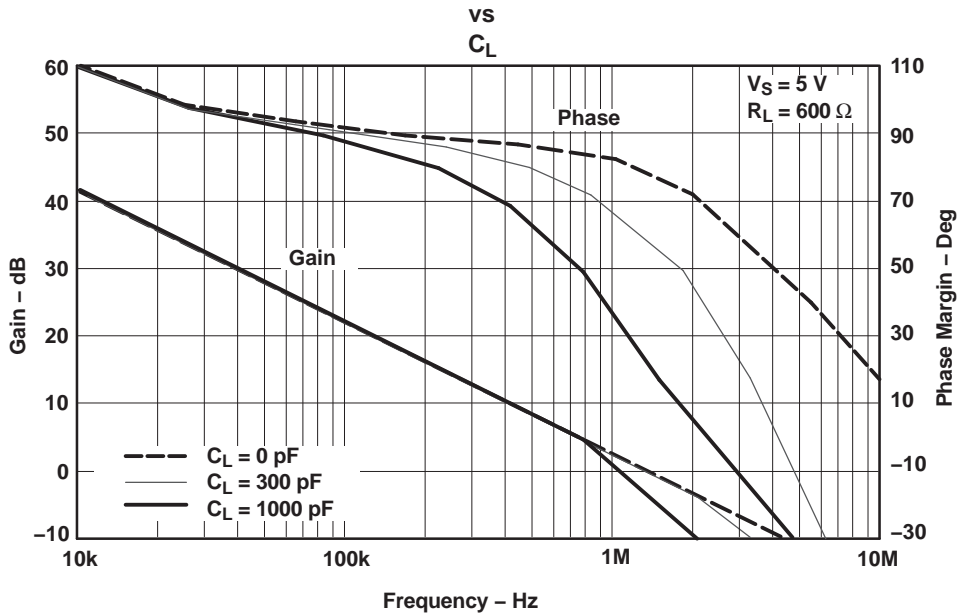


Figure 11.

TYPICAL CHARACTERISTICS (continued)

$V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

1.8-V FREQUENCY RESPONSE

vs
TEMPERATURE

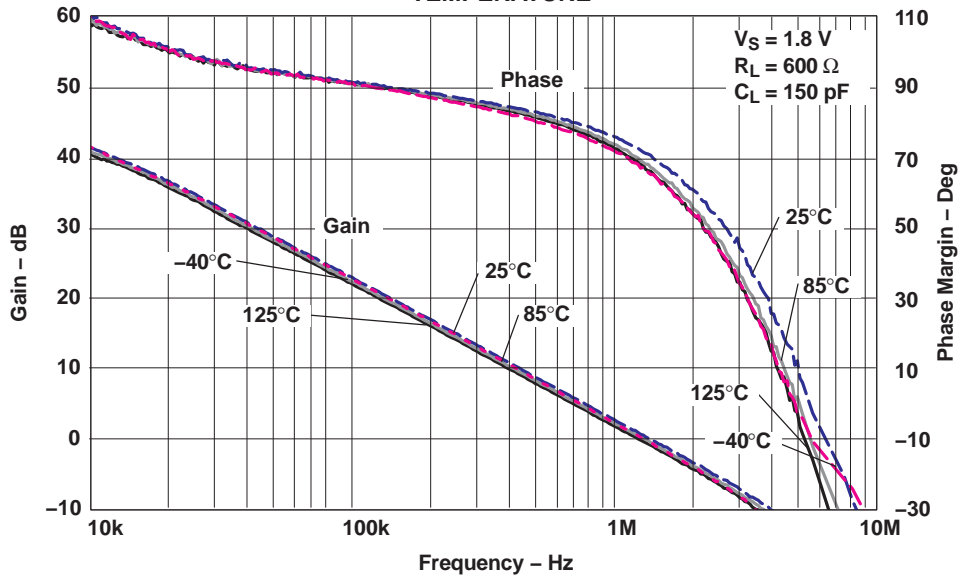


Figure 12.

5-V FREQUENCY RESPONSE

vs
TEMPERATURE

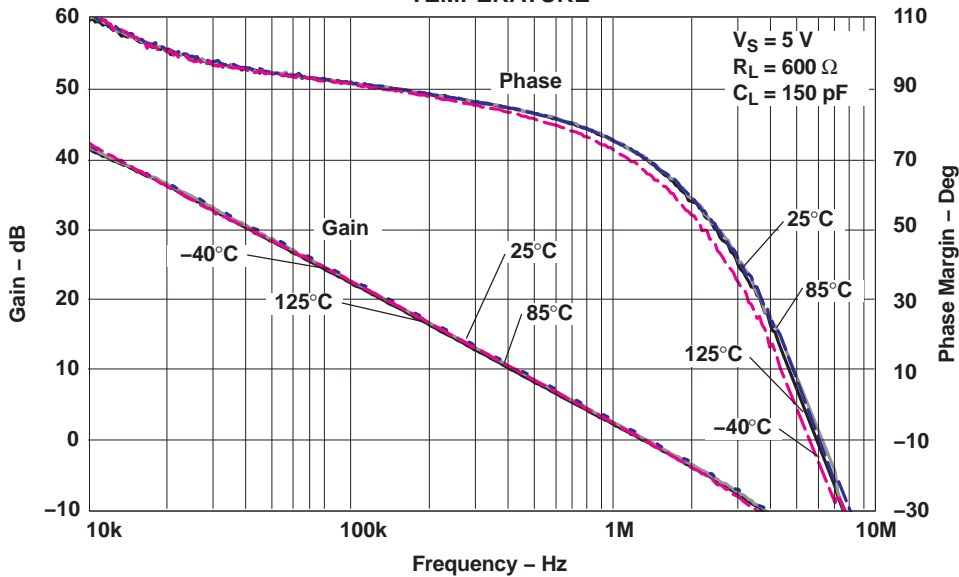


Figure 13.

TYPICAL CHARACTERISTICS (continued)

V_{CC+} = 5 V, Single Supply, T_A = 25°C (unless otherwise specified)

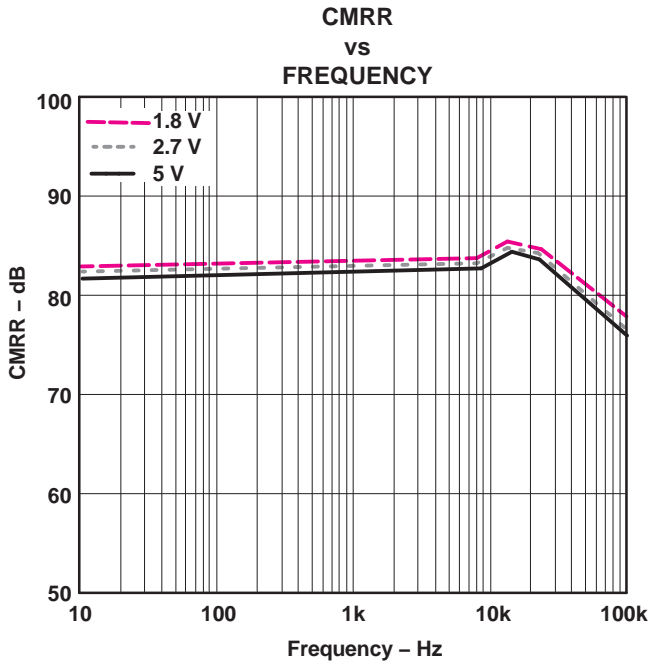


Figure 14.

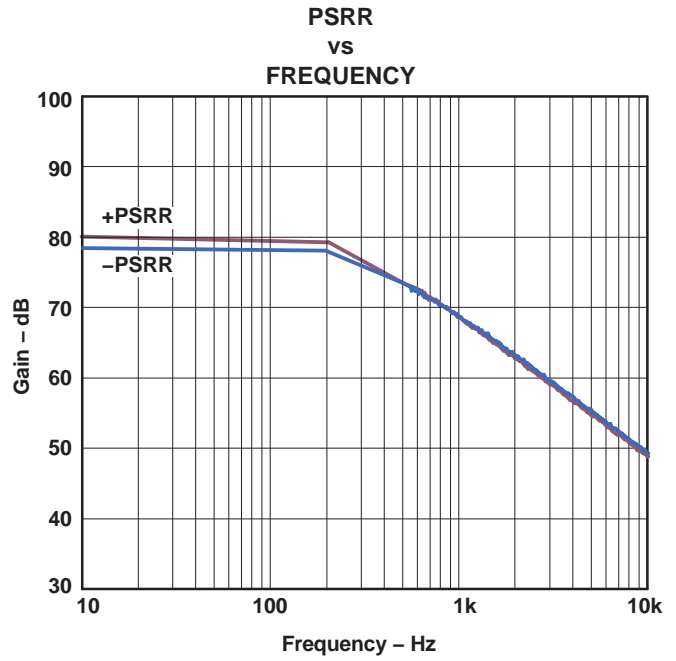


Figure 15.

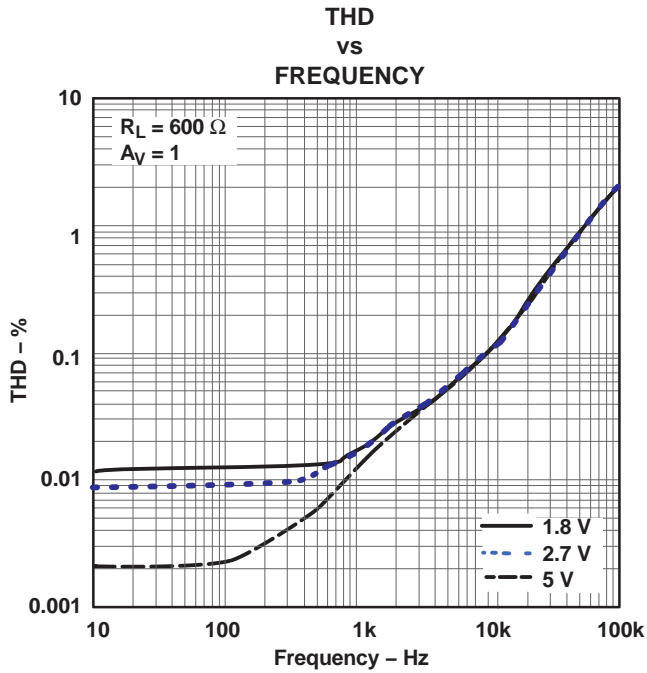


Figure 16.

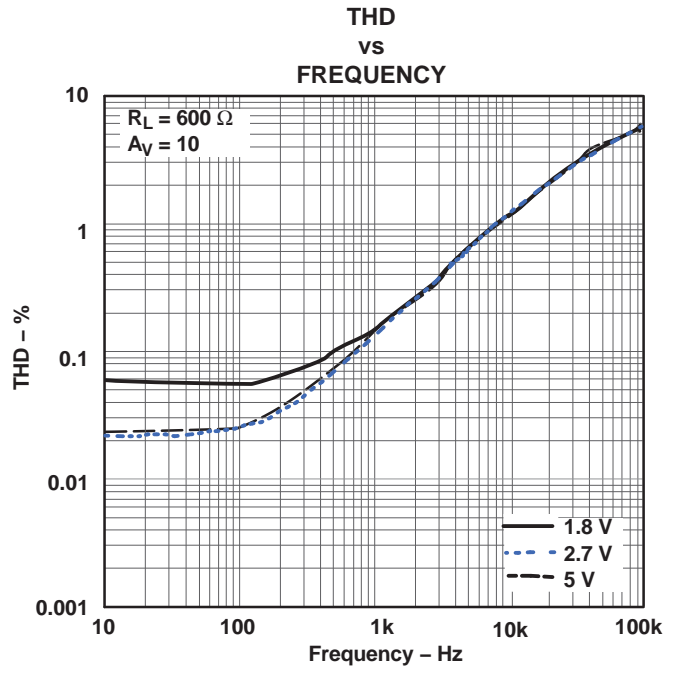


Figure 17.

TYPICAL CHARACTERISTICS (continued)

$V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

SMALL-SIGNAL NONINVERTING RESPONSE

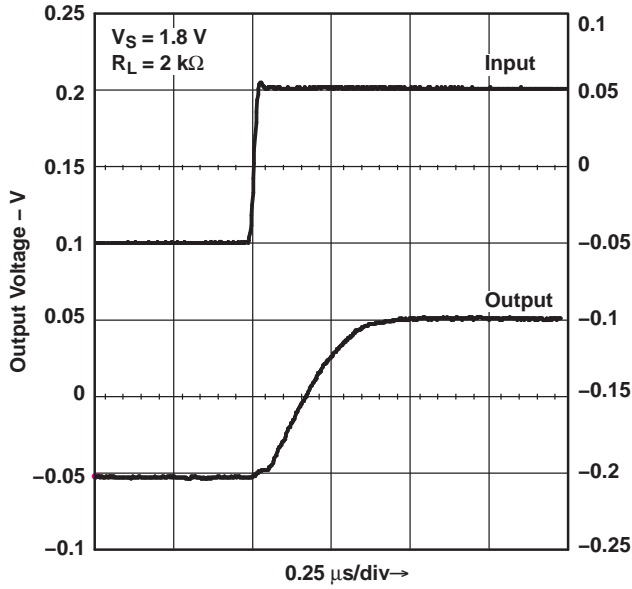


Figure 18.

SMALL-SIGNAL NONINVERTING RESPONSE

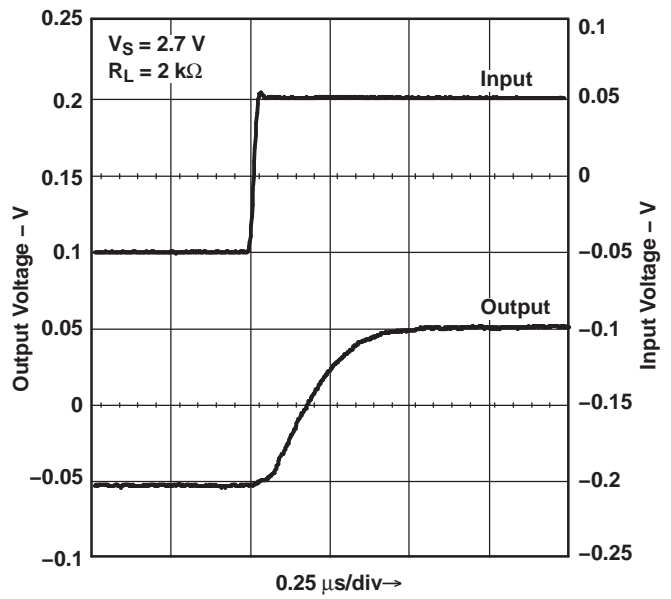


Figure 19.

SMALL-SIGNAL NONINVERTING RESPONSE

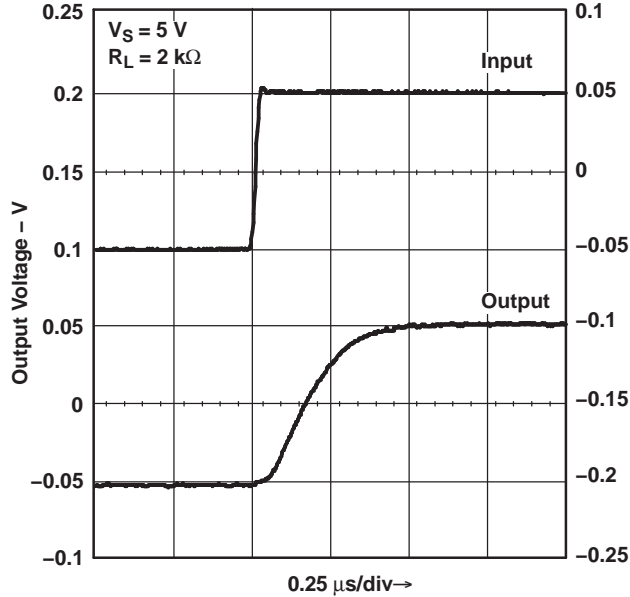


Figure 20.

LARGE-SIGNAL NONINVERTING RESPONSE

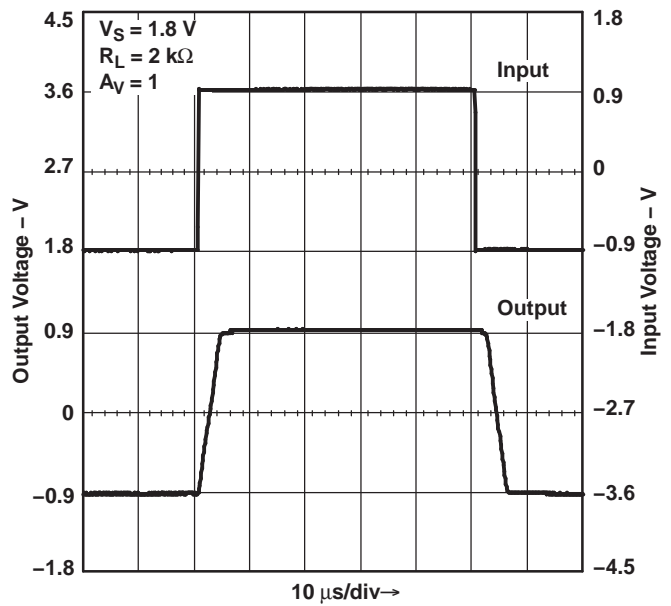


Figure 21.

TYPICAL CHARACTERISTICS (continued)

V_{CC+} = 5 V, Single Supply, T_A = 25°C (unless otherwise specified)

LARGE-SIGNAL NONINVERTING RESPONSE

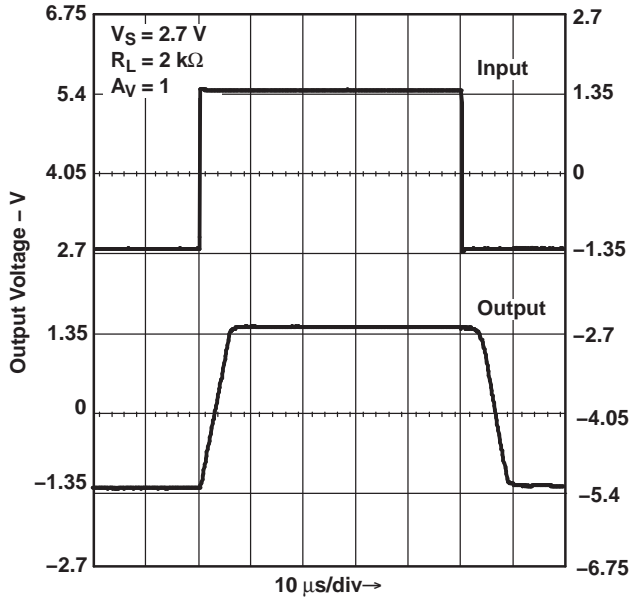


Figure 22.

LARGE-SIGNAL NONINVERTING RESPONSE

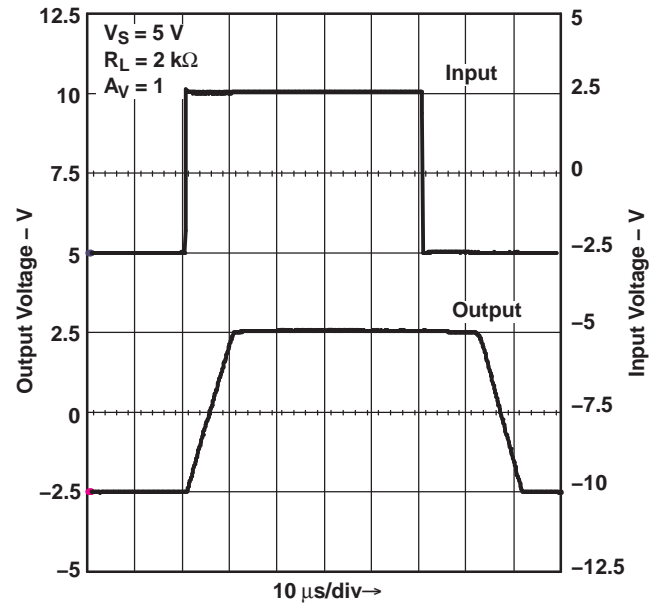


Figure 23.

OFFSET VOLTAGE vs COMMON-MODE RANGE

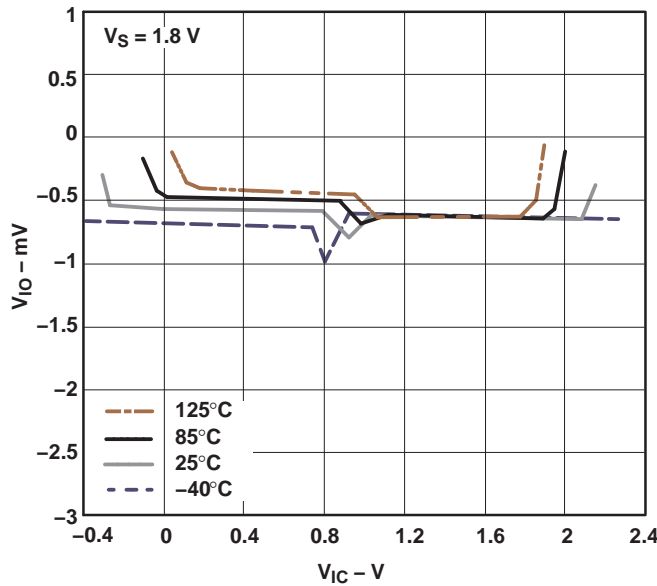


Figure 24.

OFFSET VOLTAGE vs COMMON-MODE RANGE

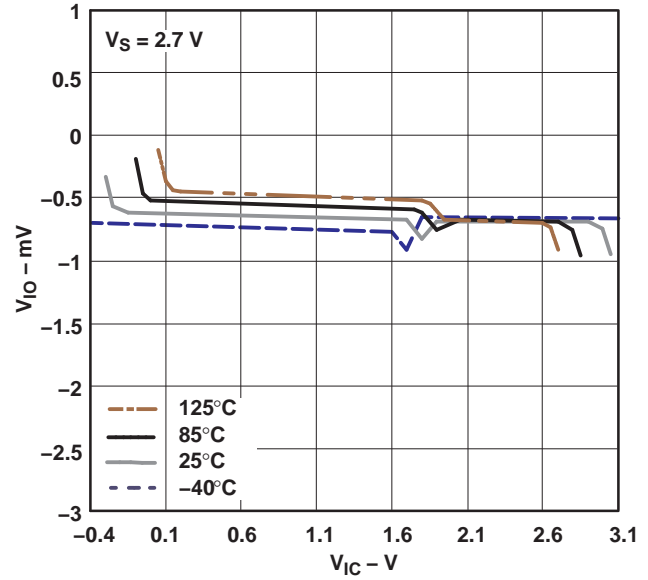
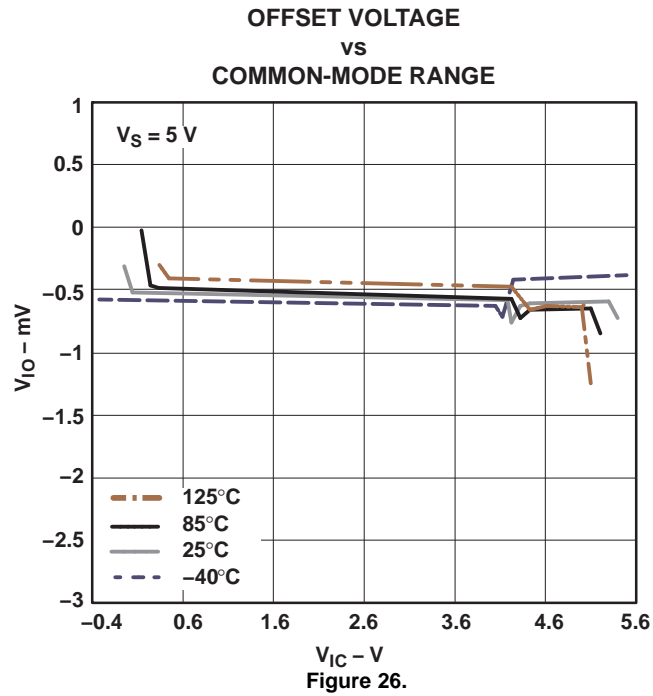


Figure 25.

TYPICAL CHARACTERISTICS (continued)

$V_{CC+} = 5\text{ V}$, Single Supply, $T_A = 25^\circ\text{C}$ (unless otherwise specified)



PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|-------------------------|----------------------|--------------|-------------------------|---------|
| LMV931IDBVR | OBSOLETE | SOT-23 | DBV | 5 | | TBD | Call TI | Call TI | -40 to 125 | (RBBB ~ RBBC ~ RBB) | |
| LMV931IDBVRE4 | OBSOLETE | SOT-23 | DBV | 5 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV931IDBVRG4 | OBSOLETE | SOT-23 | DBV | 5 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV931IDCKR | OBSOLETE | SC70 | DCK | 5 | | TBD | Call TI | Call TI | -40 to 125 | (RBB ~ RBC ~ RBI) | |
| LMV931IDCKRE4 | OBSOLETE | SC70 | DCK | 5 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV931IDCKRG4 | OBSOLETE | SC70 | DCK | 5 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV932ID | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI | -40 to 125 | MV932I | |
| LMV932IDE4 | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV932IDG4 | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV932IDGKR | OBSOLETE | VSSOP | DGK | 8 | | TBD | Call TI | Call TI | -40 to 125 | (RD6 ~ RDB) | |
| LMV932IDGKRG4 | OBSOLETE | VSSOP | DGK | 8 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV932IDR | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI | -40 to 125 | MV932I | |
| LMV932IDRE4 | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV932IDRG4 | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934ID | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | -40 to 125 | LMV934I | |
| LMV934IDE4 | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IDG4 | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IDR | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | -40 to 125 | LMV934I | |
| LMV934IDRE4 | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IDRG4 | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IPW | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI | -40 to 125 | MV934I | |
| LMV934IPWE4 | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IPWG4 | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IPWR | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI | -40 to 125 | MV934I | |
| LMV934IPWRE4 | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |
| LMV934IPWRG4 | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI | -40 to 125 | | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

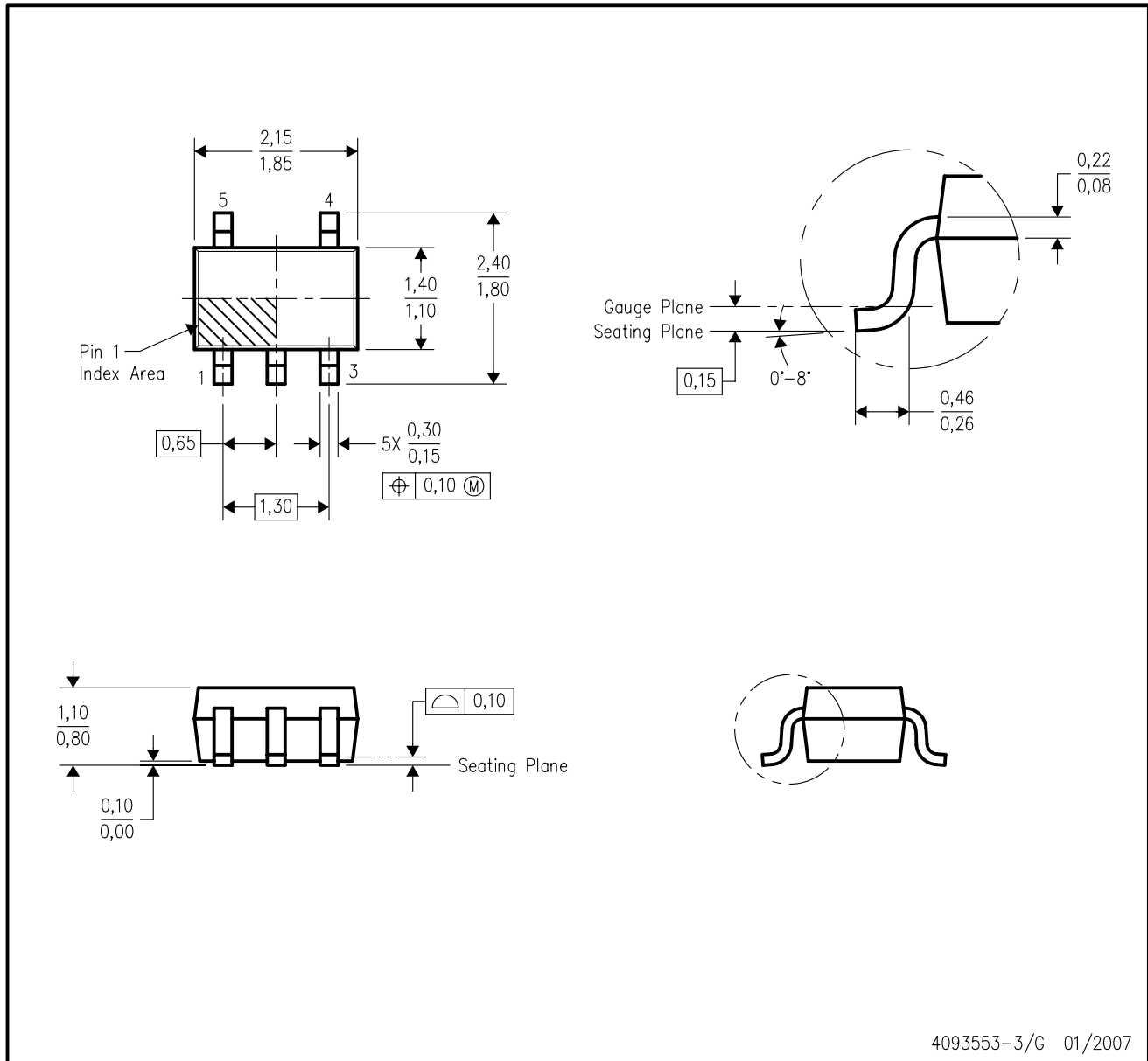
⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-203 variation AA.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 -  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G8)

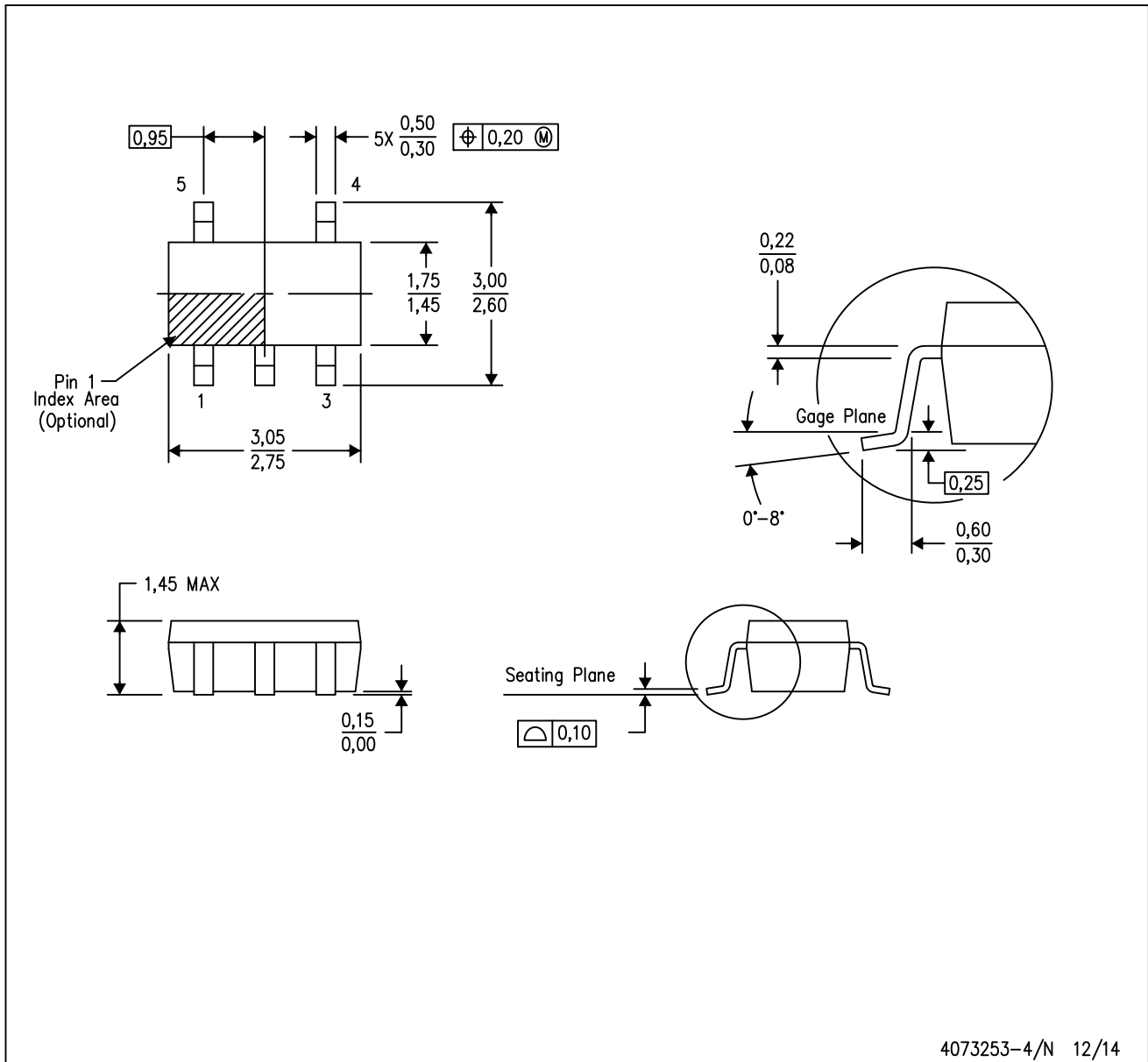
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE

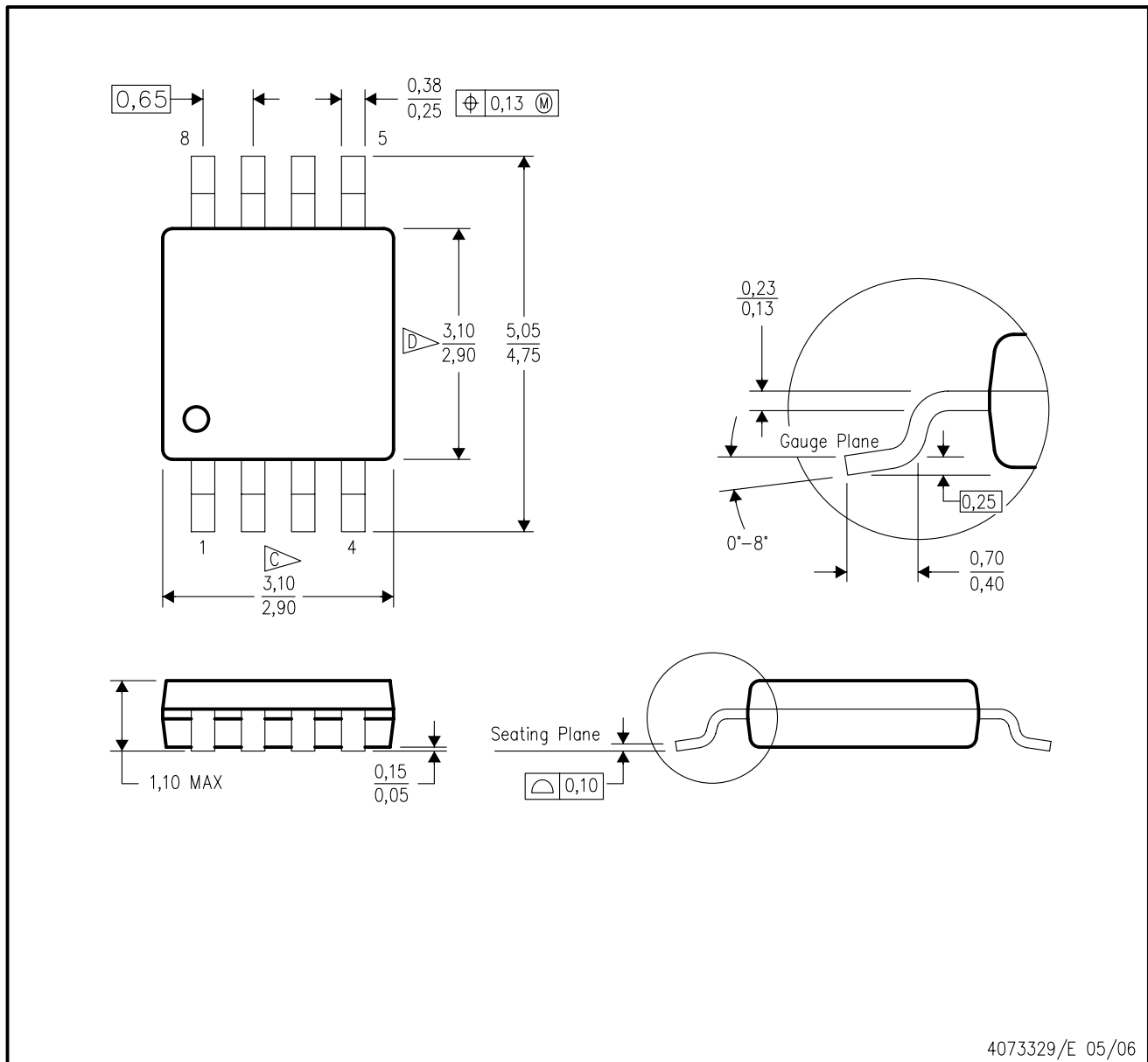


4073253-4/N 12/14

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - Falls within JEDEC MO-178 Variation AA.

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
 - E. Falls within JEDEC MO-187 variation AA, except interlead flash.

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